

## TECHNICAL DATA SHEET

|                                          |                    |
|------------------------------------------|--------------------|
| Alloy designation according to ISO 9453: | <b>Sn99,3Cu0,7</b> |
| Flux designation:                        | <b>SW26</b>        |
| Product form:                            | Cored solder wire  |
| Other known alloy markings:              | S-Sn99Cu1          |

### 1. General characteristics

The lead-free solder alloy Sn99,3Cu0,7 is manufactured by Cynel-Unipress in the first smelting of tin and copper. Its chemical composition complies with ISO 9453. Sn99,3Cu0,7 is the most cost-effective alternative to lead-containing solders. It does not contain silver. Alloy is designed for soldering in lead-free technology. It meets the requirements of the RoHS directive. It can be sold on the consumer market and also used by private individuals outside of professional applications.

### 2. Chemical composition and physical characteristics

- 2.1. Tin content: rest
- 2.2. Copper content: 0,5 – 0,9%
- 2.3. Purity class of raw materials used for smelting: min. 99,90%
- 2.4. % composition and maximum values of impurities according to ISO 9453:

| Sn   | Pb     | Sb     | Bi     | Cu              | Au     | In     | Ag     | Al     | As     | Cd     | Fe     | Ni     | Zn     | other |
|------|--------|--------|--------|-----------------|--------|--------|--------|--------|--------|--------|--------|--------|--------|-------|
| rest | 0,0700 | 0,1000 | 0,1000 | 0,5000 - 0,9000 | 0,0500 | 0,1000 | 0,1000 | 0,0010 | 0,0300 | 0,0020 | 0,0200 | 0,0100 | 0,0010 | -     |

- 2.5. Melting point: 227 °C (eutectic alloy)
- 2.6. Specific weight: ~7,31 g/cm<sup>3</sup>
- 2.7. Resistivity: 0,126 μΩ·m
- 2.8. Thermal conductivity: 66 W/m·K
- 2.9. Tensile strength at break: 300 kg/cm<sup>2</sup>
- 2.10. Elongation at break: 21%
- 2.11. Hardness: 9 HB
- 2.12. Recommended soldering temperature (tip): 320 - 360 °C (for nickel plated elements up to 400 °C)

### 3. SW26 flux

Halide flux based on modified rosin. It provides very good solderability in popular applications in all branches of industry, as well as in hobby applications. The flux works on most metal surfaces except aluminum, its alloys and stainless steel. Flux residues after soldering do not have to be removed and may remain on the soldered surface. Alcohol-based solvents are recommended for washing up the residues.

- 3.1. Designation according to DIN 8511: SW26
- 3.2. Designation according to ISO 9454-1: 1.1.2
- 3.3. Designation according to J-STD-004: ROL1
- 3.4. Standard flux contents: 2,2% i 2,5% ± 0,2%  
other flux contents from 0.8% to 3.5% are negotiable
- 3.5. Halide content: 0,5%
- 3.6. Acid number: 180 mg KOH/g
- 3.7. Copper mirror test: passed (in accordance with J-STD-004 IPC-TM-650 2.3.32D)
- 3.8. Corrosiveness: noncorrosive

### 4. Other information

- 4.1. Available diameters [mm]: 0,25 • 0,38 • 0,50 • 0,56 • 0,70 • 0,80 • 0,90 • 1,00 • 1,20 • 1,50 • 2,00 • 2,50 • 3,00 • 4,00  
Other wire diameters possible to be agreed.
- 4.2. Spools and packaging: Spools 100 g - carton box of 30 pcs  
Spools 250 g - carton box of 5 kg  
Spools 500 g - carton box of 5 kg  
Spools 1 kg - carton box of 10 kg  
Other spool sizes possible to be agreed.
- 4.3. Expiry date: 5 full years from the end of the year of production given in the product batch number.  
E.g.: batch no. 21112233 = year of manufacture 2022, validity until the end of 2027.
- 4.4. Markings: Spools and carton boxes marked with alloy, flux type, percentage content of flux, diameter, weight and batch number.
- 4.5. Storage: Store at room temperature in a dry place out of reach of children.

The subject of the specification described above complies with Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of hazardous substances in electrical and electronic equipment and with the Commission Delegated Directive (EU) 2015/863 of 31 March 2015, amending Annex II to Directive 2011/65/EU of the European Parliament and of the Council as regards the list of restricted substances as amended. The subject does not contain any of the substances listed in the RoHS Directive, i.e. lead, mercury, cadmium, hexavalent chromium, polybrominated biphenyls (PBB), polybrominated diphenyl ethers (PBDE), di(2 ethylhexyl phthalate (DEHP), butyl benzyl phthalate (BBP), dibutyl phthalate (DBP), diisobutyl phthalate (DIBP) above 0.1% at a homogeneous level of material, unless it is exempted.



ISO 9001:2015  
ISO 14001:2015